

March 2015

FAIRCHILD

FDD5614P

60V P-Channel PowerTrench[®] MOSFET

General Description

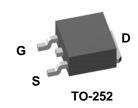
This 60V P-Channel MOSFET uses Fairchild's high voltage PowerTrench process. It has been optimized for power management applications.

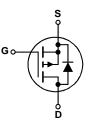
Applications

- DC/DC converter
- Power management
- Load switch

Features

- -15 A, -60 V. $R_{DS(ON)} = 100 \text{ m}\Omega @ V_{GS} = -10 \text{ V}$ $R_{DS(ON)} = 130 \text{ m}\Omega @ V_{GS} = -4.5 \text{ V}$
- Fast switching speed
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability





Absolute Maximum Ratings TA=25°C unless otherwise noted

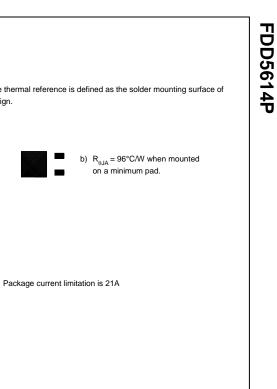
Drain-Source Voltage Gate-Source Voltage Drain Current – Continuous – Pulsed Power Dissipation for Single Operation	(Note 3) (Note 1a) (Note 1) (Note 1a)	-60 ± 20 -15 -45 42 3.8	V V A W
Drain Current – Continuous – Pulsed	(Note 1a) (Note 1)	-15 -45 42	A
– Pulsed	(Note 1a) (Note 1)	-45 42	
	(Note 1)	42	W
Power Dissipation for Single Operation	. ,		W
	(Note 1a)	38	
		0.0	
	(Note 1b)	1.6	
Operating and Storage Junction Temperat	ure Range	-55 to +175	°C
Characteristics			
Thermal Resistance, Junction-to-Case	(Note 1)	3.5	°C/W
Thermal Resistance, Junction-to-Ambient	(Note 1a)	40	
Thermal Resistance, Junction-to-Ambient	(Note 1b)	96	°C/W
	, ,		
	I Characteristics Thermal Resistance, Junction-to-Case Thermal Resistance, Junction-to-Ambient Thermal Resistance, Junction-to-Ambient e Marking and Ordering Info	Operating and Storage Junction Temperature Range I Characteristics Thermal Resistance, Junction-to-Case (Note 1) Thermal Resistance, Junction-to-Ambient (Note 1a)	Operating and Storage Junction Temperature Range -55 to +175 I Characteristics Image: Characteristics Thermal Resistance, Junction-to-Case (Note 1) Thermal Resistance, Junction-to-Ambient (Note 1a) Thermal Resistance, Junction-to-Ambient (Note 1b) 96 96 e Marking and Ordering Information 1

Device Marking	Device	Reel Size	Tape width	Quantity	
FDD5614P	FDD5614P	13"	16mm	2500 units	

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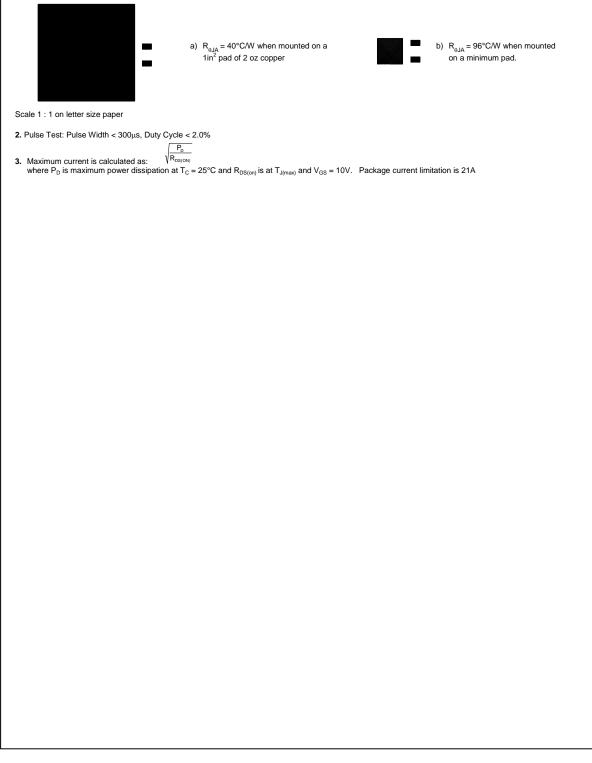
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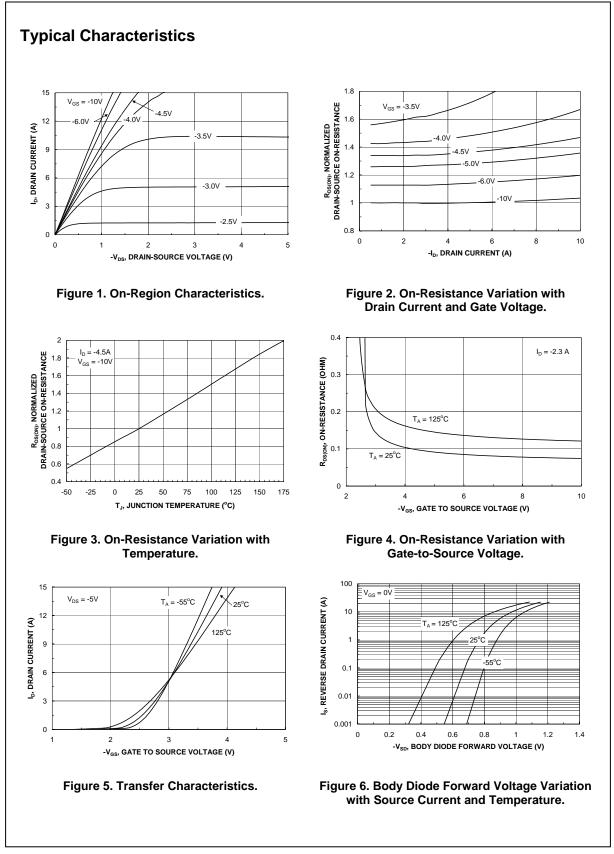
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-So	burce Avalanche Ratings (Note	1)				
W _{DSS}	Single Pulse Drain-Source Avalanche Energy	$V_{DD} = -30 \text{ V}, I_D = -4.5 \text{ A}$			90	mJ
I _{AR}	Maximum Drain-Source Avalanche Current				-4.5	A
Off Char	acteristics			1		
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = -250 \mu A$	-60			V
<u>ΔBV_{DSS}</u> ΔTj	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C		-49		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}} = -48 \text{ V}, V_{\text{GS}} = 0 \text{ V}$			-1	μΑ
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = 20V, \qquad V_{DS} = 0 V$			100	nA
	Gate–Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-1	-1.6	-3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu A$, Referenced to $25^{\circ}C$		4		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = -10 \ V, I_D = -4.5 \ A \\ V_{GS} = -4.5 \ V, I_D = -3.9 \ A \\ V_{GS} = -10 \ V, I_D = -4.5 \ A, T_J = 125^\circ C \end{array} $		76 99 137	100 130 185	mΩ
I _{D(on)}	On-State Drain Current	$V_{GS} = -10 \text{ V}, \qquad V_{DS} = -5 \text{ V}$	-20			Α
g _{FS}	Forward Transconductance	$V_{\text{DS}} = -5 \text{ V}, \qquad I_{\text{D}} = -3 \text{ A}$		8		S
Dvnamic	c Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = -30 V$, $V_{GS} = 0 V$,		759		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		90		pF
C _{rss}	Reverse Transfer Capacitance			39		pF
Switchin	ng Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = -30 V$, $I_D = -1 A$,		7	14	ns
tr	Turn–On Rise Time	$V_{GS} = -10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		10	20	ns
t _{d(off)}	Turn–Off Delay Time]		19	34	ns
t _f	Turn–Off Fall Time			12	22	ns
Qg	Total Gate Charge	$V_{DS} = -30V, \qquad I_{D} = -4.5 \text{ A},$		15	24	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = -10 V$		2.5		nC
Q _{gd}	Gate-Drain Charge			3.0		nC
Drain-So	ource Diode Characteristics	and Maximum Ratings				
ls	Maximum Continuous Drain-Source	Diode Forward Current			-3.2	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \ V, I_S = -3.2 \ A (\text{Note 2})$		-0.8	-1.2	V



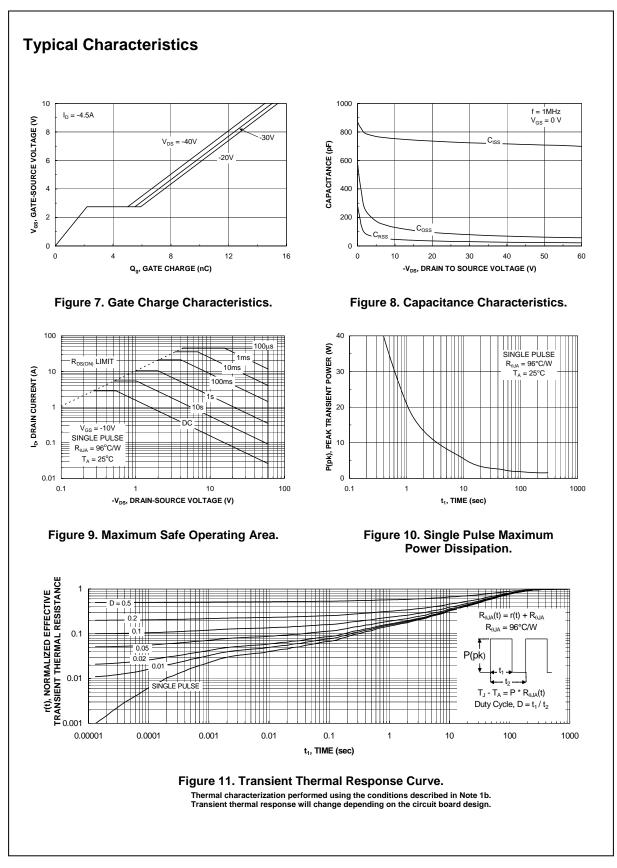
1. R_{0.4} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.

Notes:



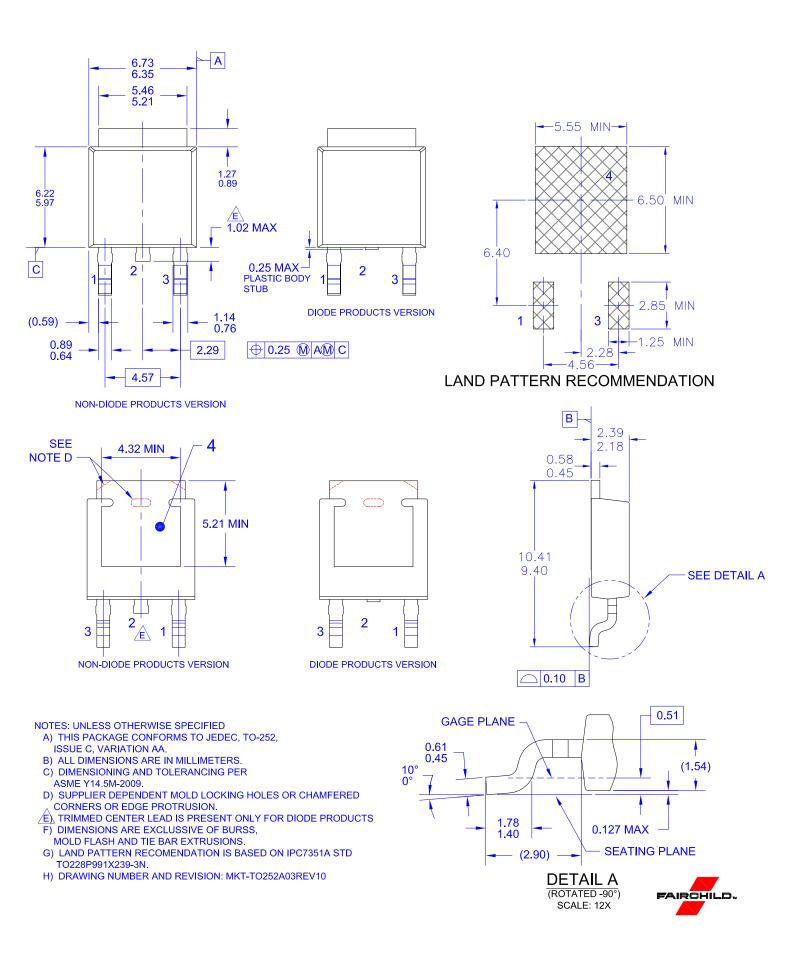


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